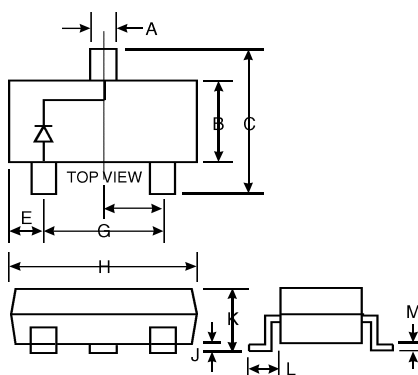


Features

Fast Switching Speed
 Surface Mount Package Ideally Suited for Automatic Insertion
 For General Purpose Switching Applications
 High Conductance

Mechanical Data

Case: SOT-23, Molded Plastic
 Terminals: Solderable per MIL-STD-202, Method 208
 Polarity: See Diagram
 Weight: 0.008 grams (approx.)



SOT-23		
Dim	Min	Max
A	0.37	0.51
B	1.19	1.40
C	2.10	2.50
D	0.89	1.05
E	0.45	0.61
G	1.78	2.05
H	2.65	3.05
J	0.013	0.15
K	0.89	1.10
L	0.45	0.61
M	0.076	0.178
All Dimensions in mm		

Maximum Ratings @ $T_A = 25\text{ C}$ unless otherwise specified

Characteristic	Symbol	BAS19	BAS20	BAS21	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage	V_{RWM} V_R	100	150	200	V
RMS Reverse Voltage	$V_{R(RMS)}$	71	106	141	V
Forward Continuous Current (Note 1)	I_{FM}		400		mA
Average Rectified Output Current (Note 1)	I_O		200		mA
Non-Repetitive Peak Forward Surge Current @ $t = 1.0\text{ s}$ @ $t = 1.0\text{ s}$	I_{FSM}		2.5 0.5		A
Repetitive Peak Forward Surge Current	I_{FRM}		625		mA
Power Dissipation	P_d		250		mW
Thermal Resistance Junction to Ambient Air (Note 1)	R_{JA}		500		K/W
Operating and Storage Temperature Range	T_j, T_{STG}		-65 to +150		C

Electrical Characteristics @ $T_A = 25\text{ C}$ unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Maximum Forward Voltage	V_{FM}		1.0 1.25	V	$I_F = 100\text{mA}$ $I_F = 200\text{mA}$
Maximum Peak Reverse Current @ Rated DC Blocking Voltage	I_{RM}		100 15	nA A	$T_j = 25\text{ C}$ $T_j = 100\text{ C}$
Junction Capacitance	C_j		5.0	pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}		50	ns	$I_F = I_R = 30\text{mA}$, $I_{rr} = 0.1 \times I_R, R_L = 100$

Note: 1. Valid provided that terminals are kept at ambient temperature.

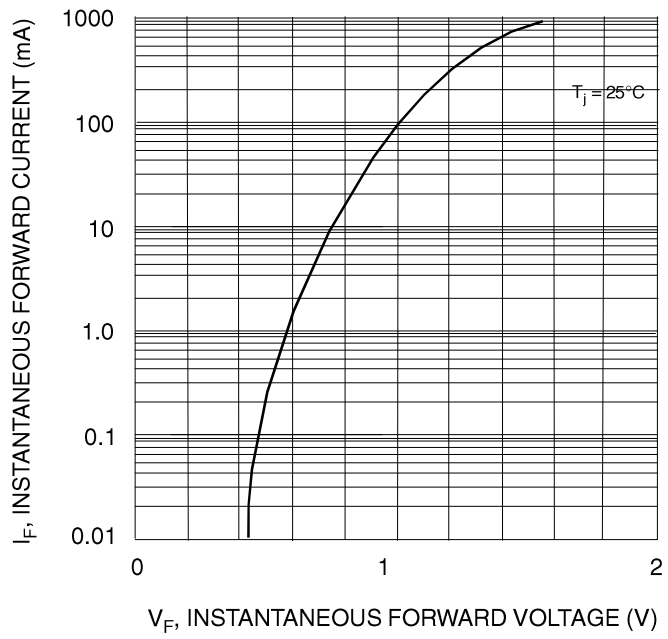


Fig. 1 Forward Characteristics

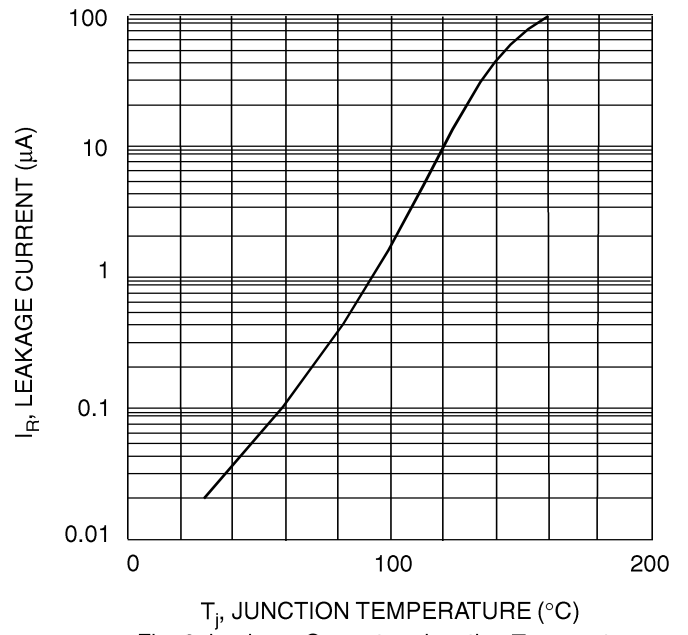


Fig. 2 Leakage Current vs Junction Temperature